

Features

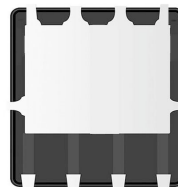
- High density cell design for ultra low $R_{DS(ON)}$
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high EAS

Product Summary

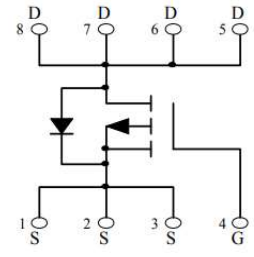
V_{DS}	$R_{DS(ON)}$ TYP	I_D MAX
-30V	11.5mΩ@-10V	-30A
	18mΩ@-4.5V	

Application

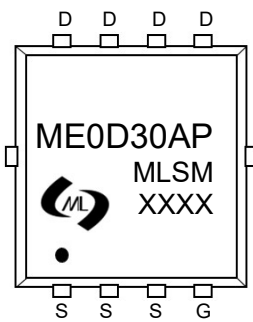
- Battery and loading switching
- Excellent package for good heat dissipation



PDFN3X3-8L view



Schematic diagram



Marking and pin assignment

ME0D30AP : Device code
XXXX : Code



Pb-Free



Halogen-Free

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
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Common Ratings (TC=25°C Unless Otherwise Noted)

V_{DS}	Drain-Source Breakdown Voltage	-30	V
V_{GS}	Gate-Source Voltage	±20	V
E_{AS}	Single pulse avalanche energy ^{Note 1}	85	mJ
T_J, T_{STG}	Storage Temperature Range	-55 to 175	°C
I_S	Diode Continuous Forward Current	$T_C=25^\circ\text{C}$ -30	A

Mounted on Large Heat Sink

I_{DM}	Pulse Drain Current Tested	$T_C=25^\circ\text{C}$ -150	A
I_D	Continuous Drain Current	$T_C=25^\circ\text{C}$ -30	A
P_D	Maximum Power Dissipation	$T_C=25^\circ\text{C}$ 25	W
$R_{\theta JA}$	Thermal Resistance Junction-Ambient	55	°C/W

Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
ME0D30AP	PDFN3X3-8L	ME0D30AP	5,000	10,000	70,000	13"reel

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-30	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-30V, V _{GS} =0V	--	--	-1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-1	-1.5	-2.5	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =-10V, I _D =-10A	--	11.5	22	mΩ
		V _{GS} =-4.5V, I _D =-8A	--	18	30	mΩ

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated)

C _{ISS}	Input Capacitance	V _{DS} =-15V, V _{GS} =0V, f=1MHz	--	1500	--	pF
C _{OSS}	Output Capacitance		--	327	--	pF
C _{RSS}	Reverse Transfer Capacitance		--	276	--	pF

Switching Characteristics

Q _g	Total Gate Charge	V _{DD} =-15V, I _D =-10A, V _{GS} =-10V	--	30	--	nC
Q _{gs}	Gate Source Charge		--	5.3	--	nC
Q _{gd}	Gate Drain Charge		--	7.6	--	nC
t _{d(on)}	Turn-on Delay Time	V _{DS} =-15V, I _D =-10A, V _{GS} =-10V, R _G =2.5Ω	--	14	--	nS
t _r	Turn-on Rise Time		--	20	--	nS
t _{d(off)}	Turn-Off Delay Time		--	95	--	nS
t _f	Turn-Off Fall Time		--	65	--	nS

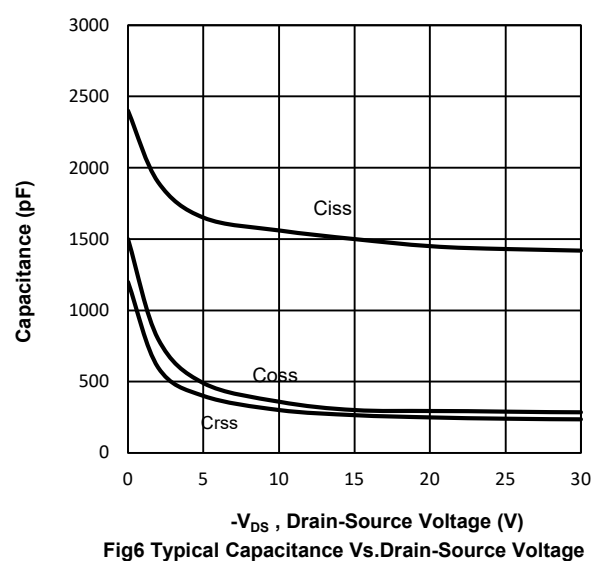
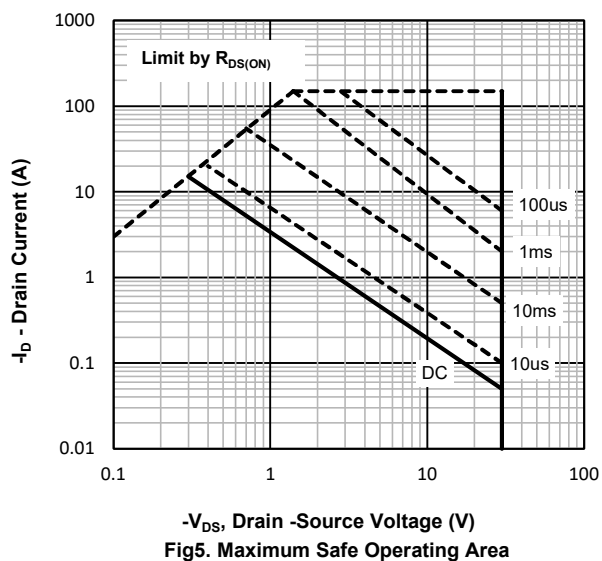
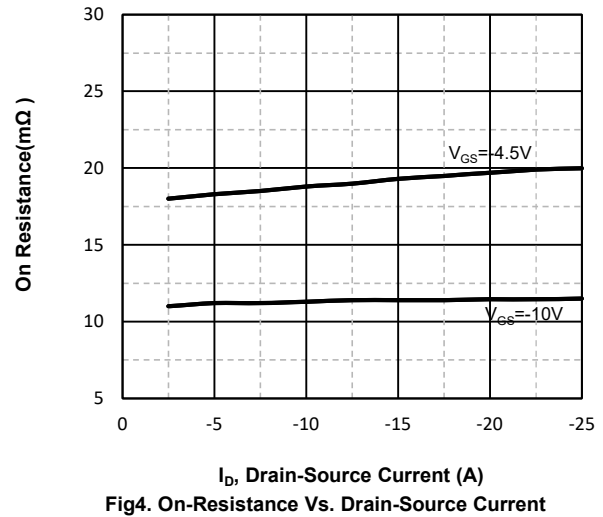
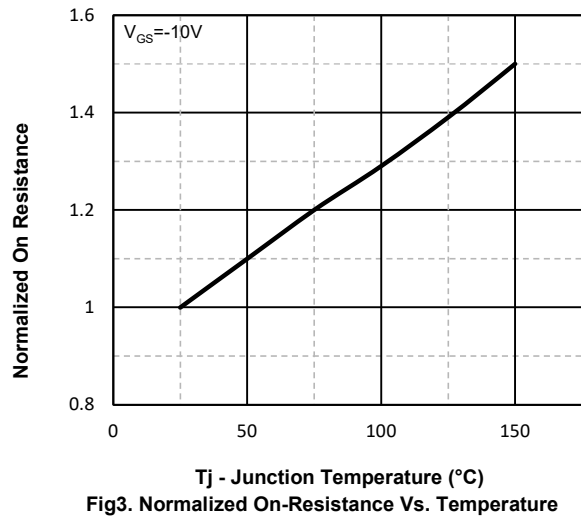
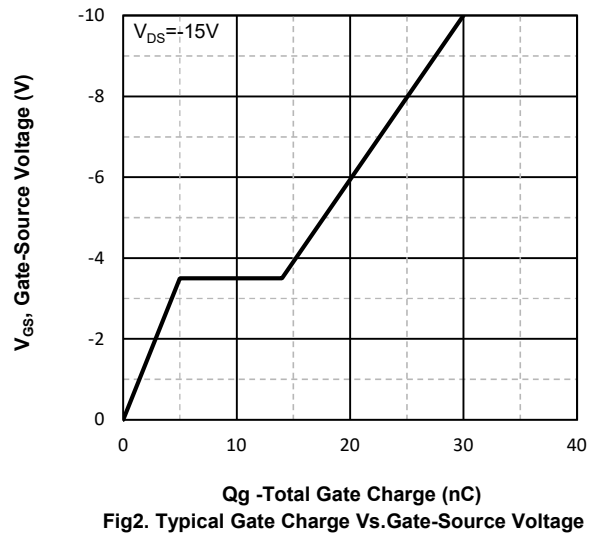
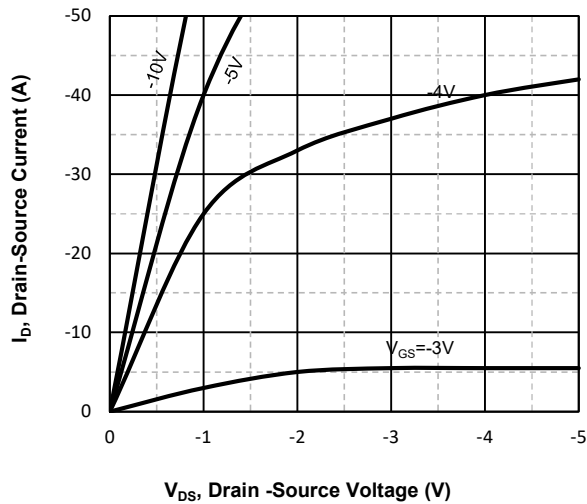
Source- Drain Diode Characteristics

V _{SD}	Forward on voltage	T _J =25°C, I _S =-10A	--	--	-1.2	V
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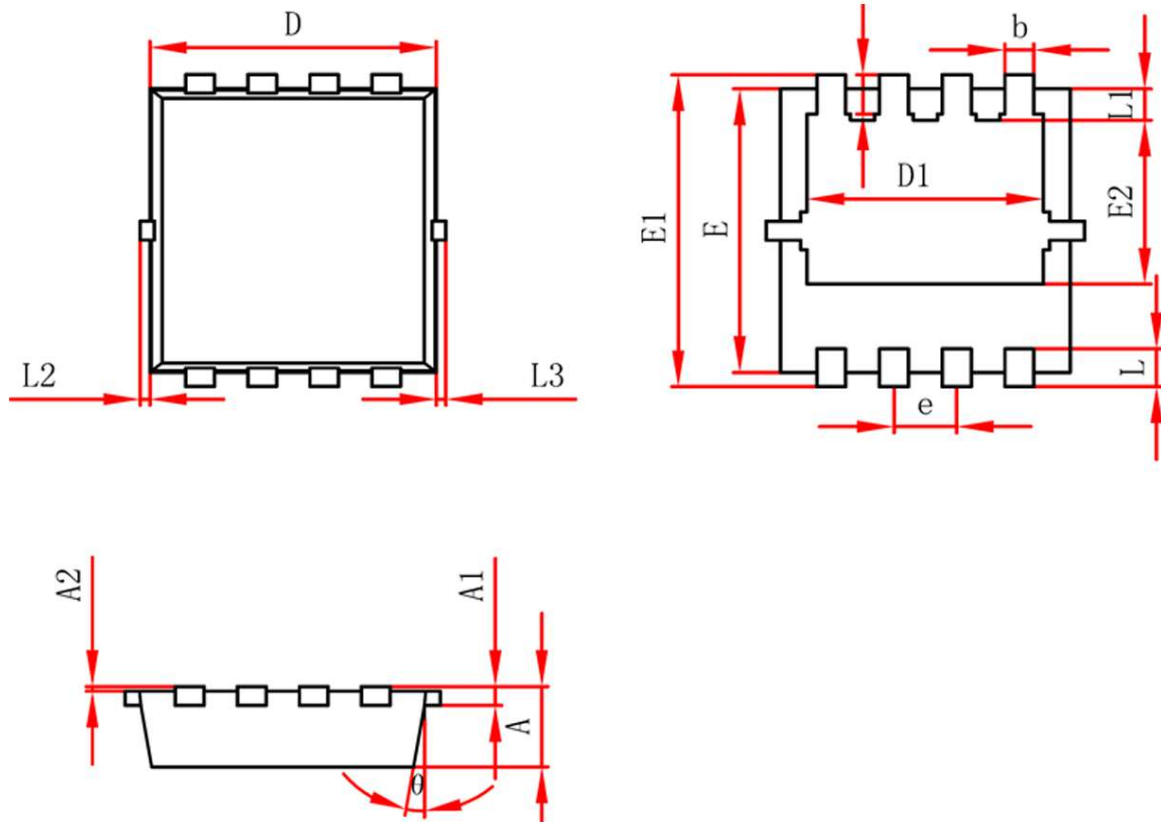
Note1:

 EAS Condition : T_J=25°C, V_{DD}=-20V, V_G=10V, L=0.5mH, R_G=25Ω

Typical Operating Characteristics



PDFN3X3-8L Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions in Inches	
	Min	Max	Min	Max
A	0.750	0.850	0.030	0.034
A1	0.152 REF.		0.006 REF.	
A2	0~0.05		0~0.002	
D	2.950	3.150	0.117	0.125
D1	2.400	2.500	0.095	0.099
E	2.950	3.050	0.117	0.121
E1	3.250	3.350	0.129	0.132
E2	1.685	1.785	0.067	0.071
b	0.250	0.350	0.010	0.014
e	0.600	0.700	0.024	0.028
L	0.350	0.450	0.014	0.018
L1	0.325	0.425	0.013	0.017
L2	0~0.100		0~0.004	
L3	0~0.100		0~0.004	
H	0.365	0.465	0.014	0.018
θ	10°	12°	10°	12°